

次世代宇宙ガンマ線衛星に向けた 大面積ピクセルを持つピクセル検出器の開発

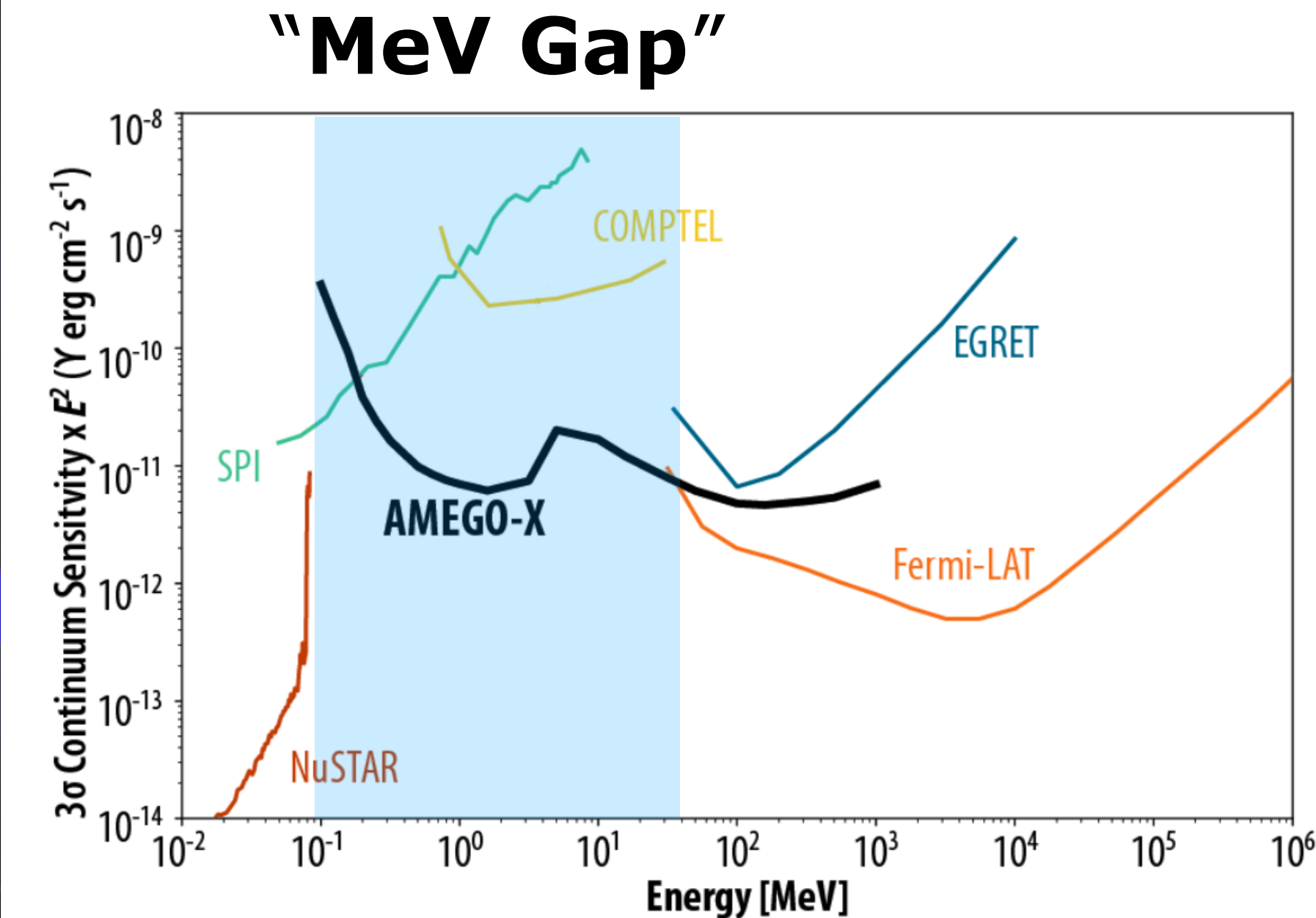
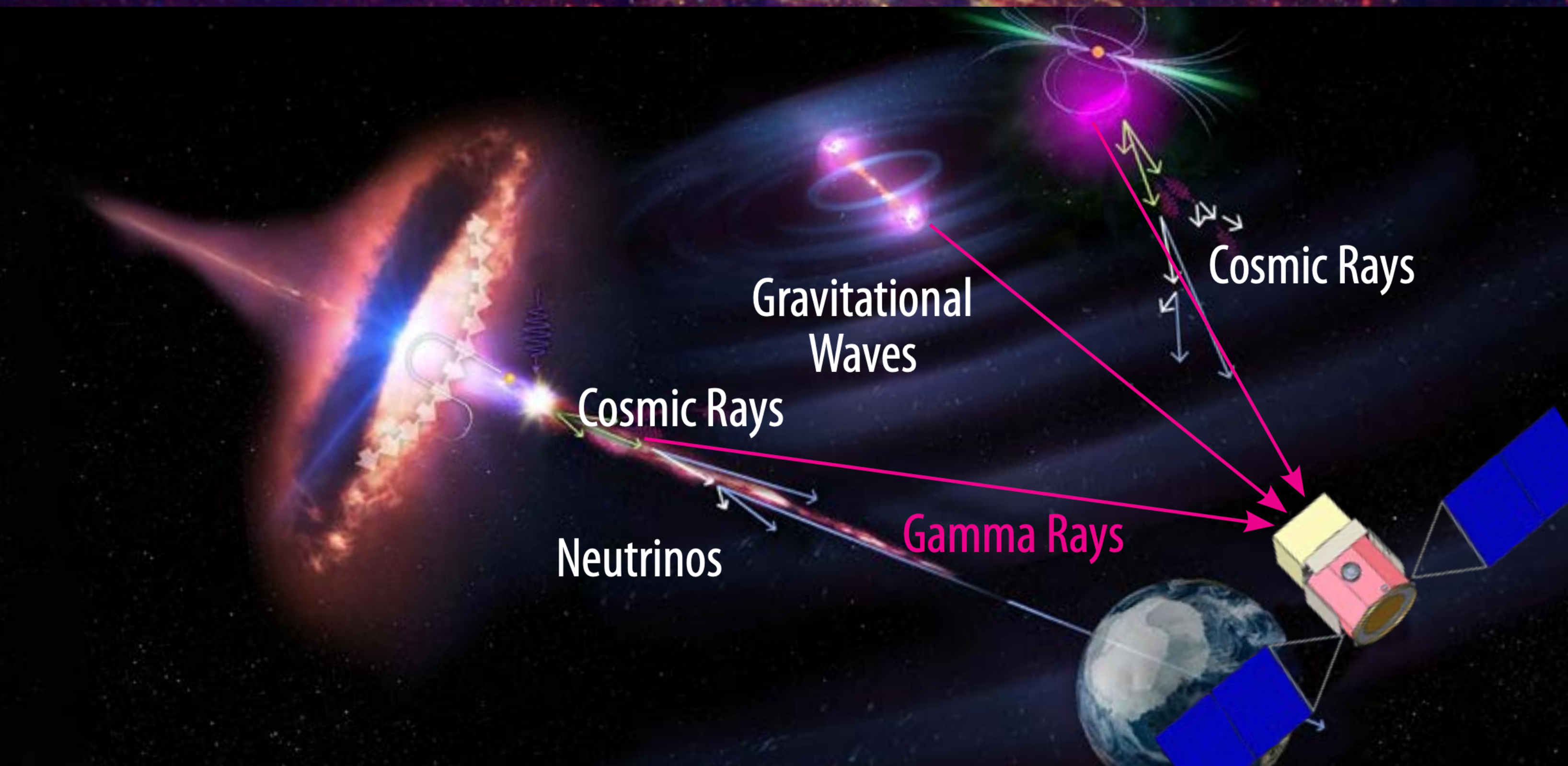
須田祐介（広島大学）

SOIPIX量子イメージング研究会2025

石川県政記念 しいのき迎賓館 @金沢

Dec 2, 2025

AMEGO-X: All-Sky MeV Gamma Satellite 2

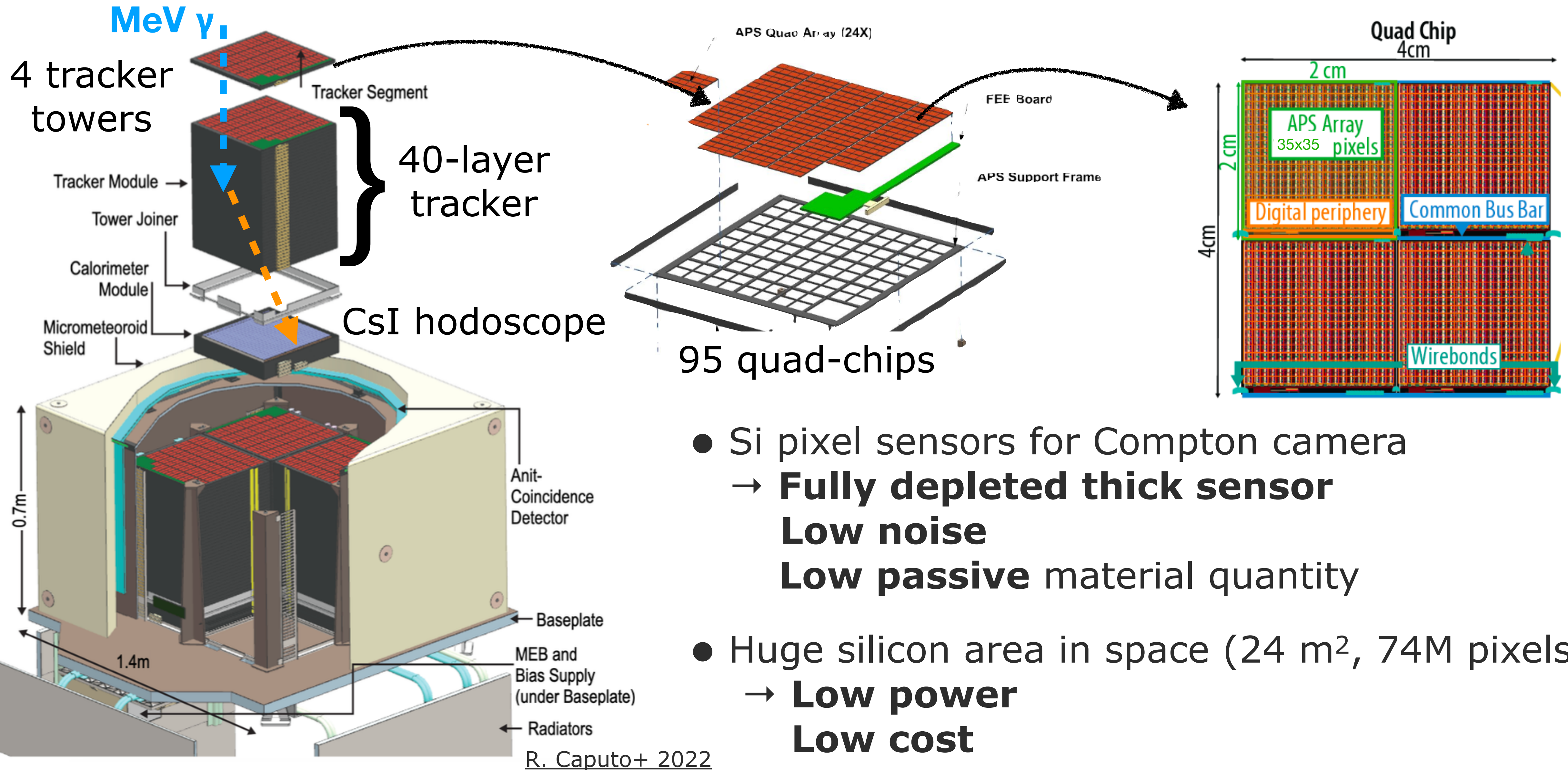


R. Caputo+ 2022

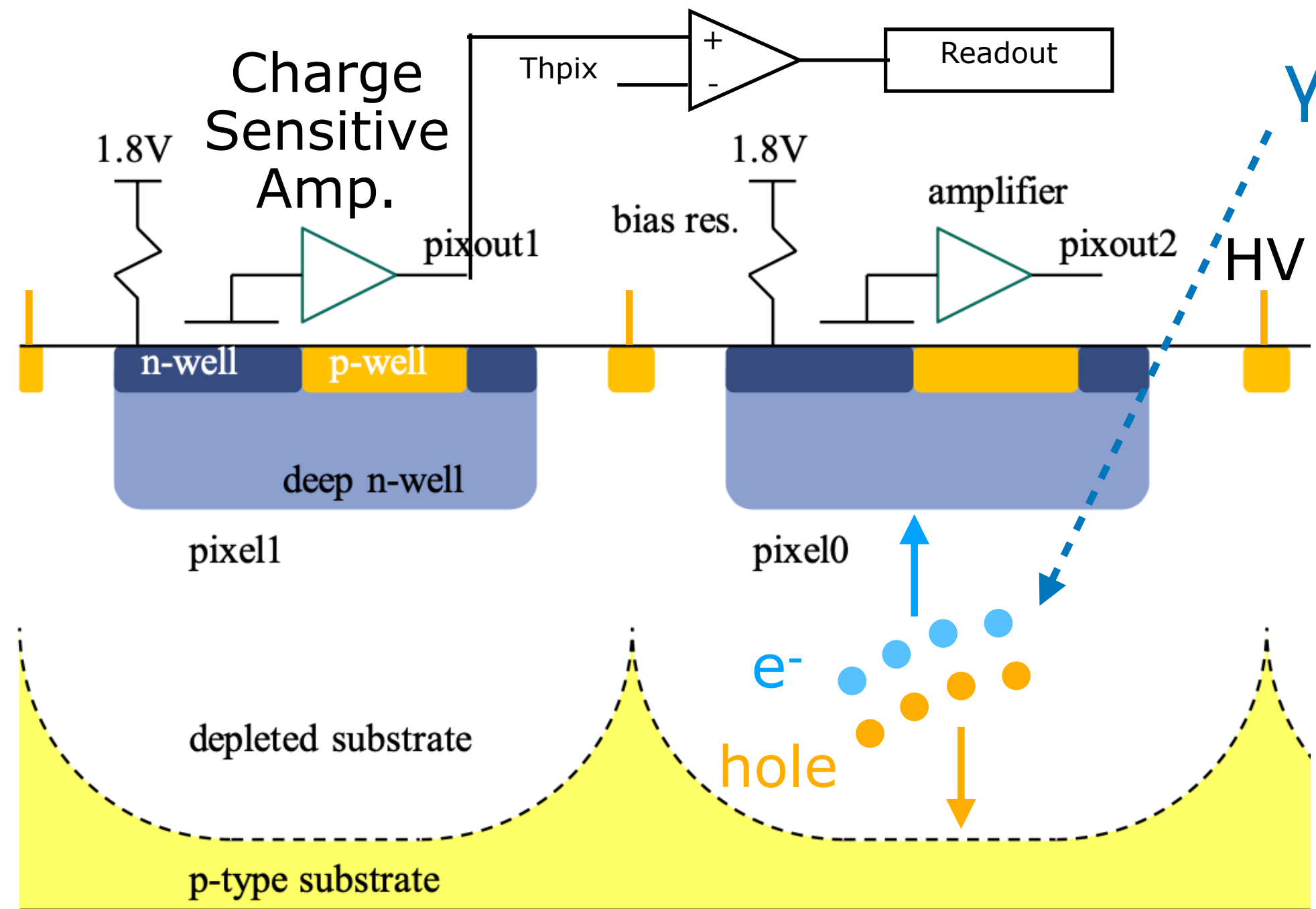
- **All-sky Medium Energy Gamma-ray Observatory eXplorer** (PI: R. Caputo, GSFC/NASA) is a proposed MeV gamma-ray mission
- Supermassive black holes: ~ 150 blazar flares/year
- Neutron star mergers: > 200 short gamma-ray bursts per year
- Galactic cosmic ray origin, multi-messenger astronomy, etc.

AMEGO-X Gamma-Ray Telescope

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HV-CMOS pixel sensor



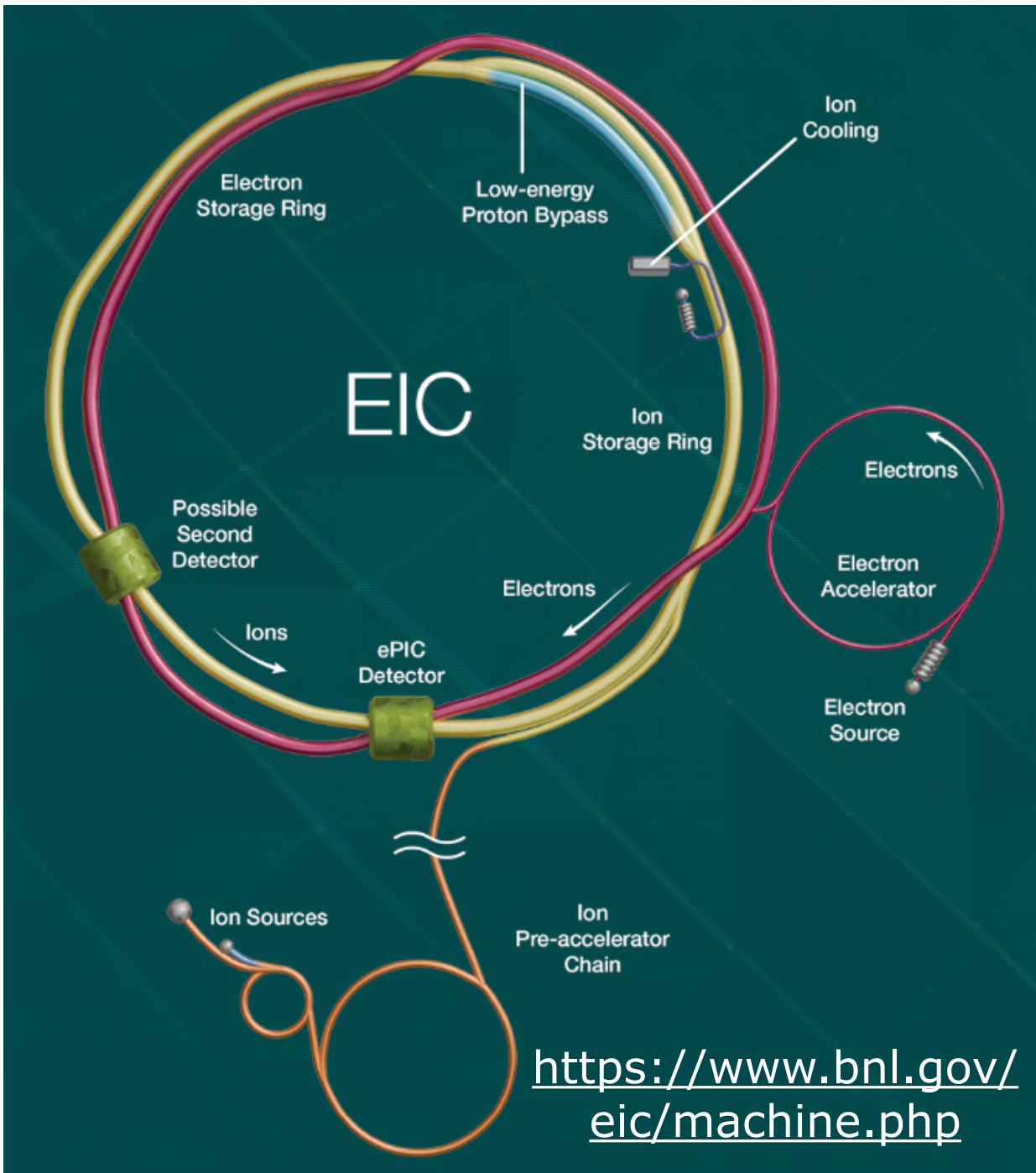
I.Peric+'07 with modifications

- Monolithic active pixel sensor (MAPS) = Detector + CMOS
 - On-pixel charge amplification and on-chip digitization
 - **Low noise**
 - **Low passive** material quantity
 - Typical CMOS wafer process & high yield
 - **Low cost**
- HV-CMOS MAPS
 - **Fully depleted thick sensor**
- Low pixel density allowing a large pixel pitch
 - **Low power**
- Time-over-Threshold measurement
 - Energy & timing

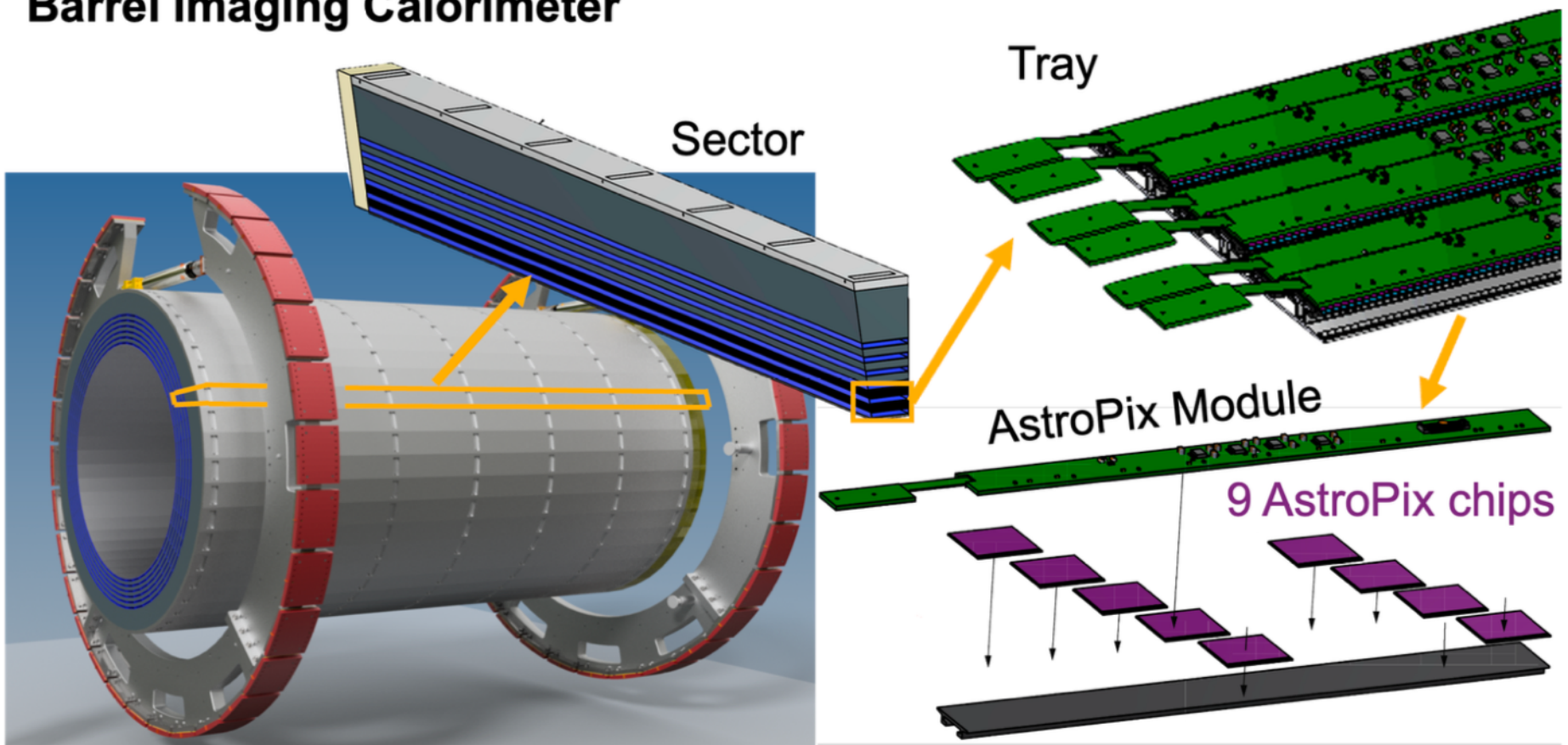
	Pixel pitch	Full depletion	Dynamic range	Energy resolution (FWHM at 122 keV)	Power
Goal	500 × 500 μm^2	500 μm	25 - 700 keV	12.2 keV	< 1.5 mW/cm ²

AstroPix @ Electron-Ion Collider

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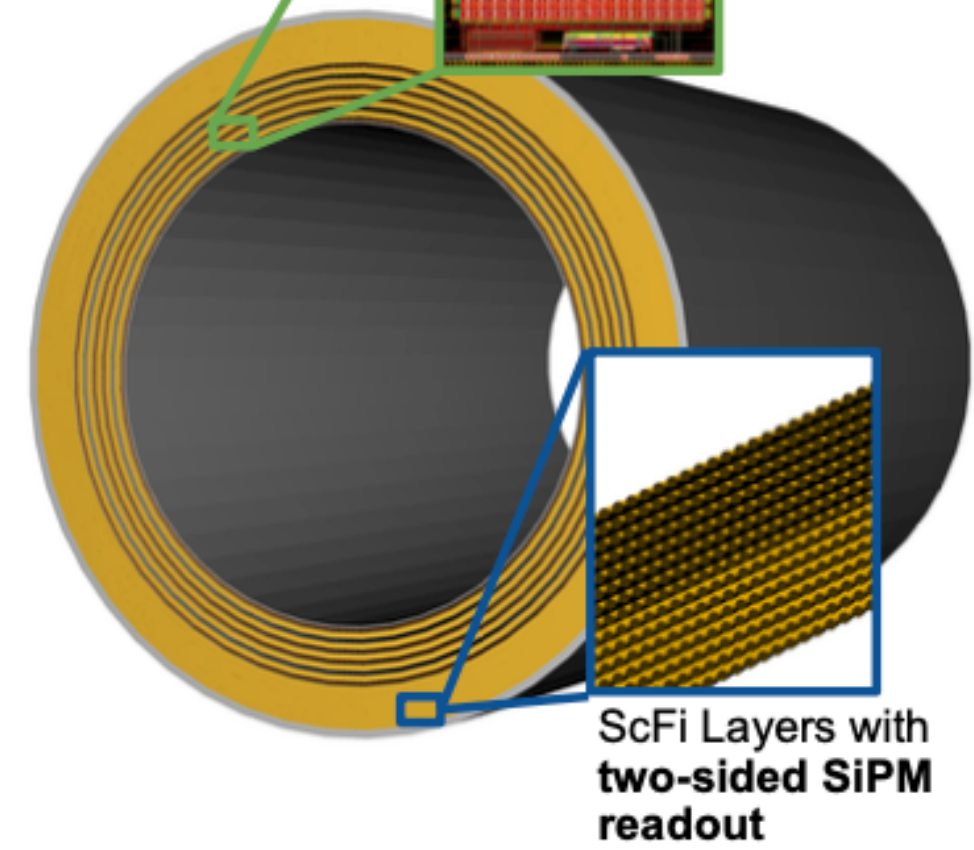
Barrel Imaging Calorimeter



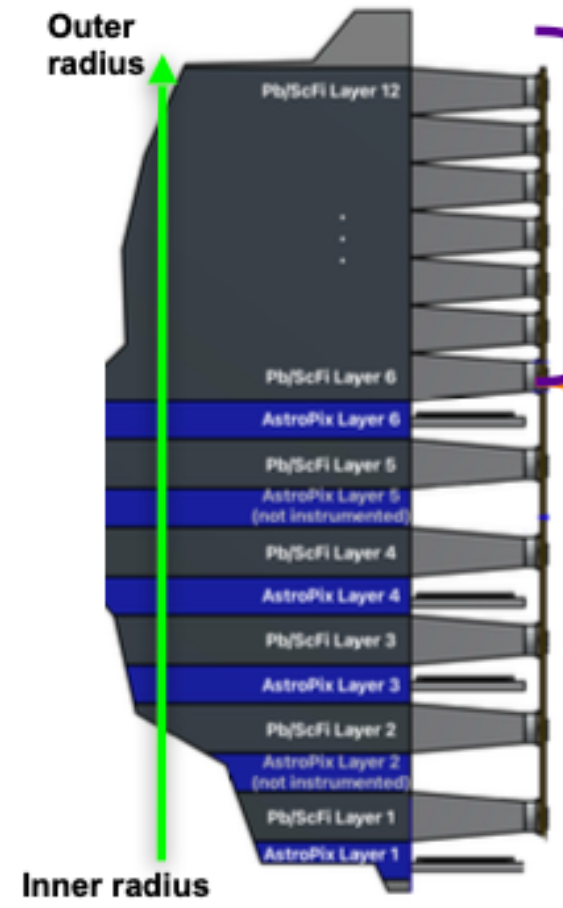
The ePIC Barrel Imaging Calorimeter (BIC)

AstroPix: silicon sensor with $500 \times 500 \mu\text{m}^2$ pixel size

The electromagnetic calorimeter is the main detector for **electron-pion separation**. The inclusive physics program requires up to 10^4 pion suppression at low momenta in the barrel



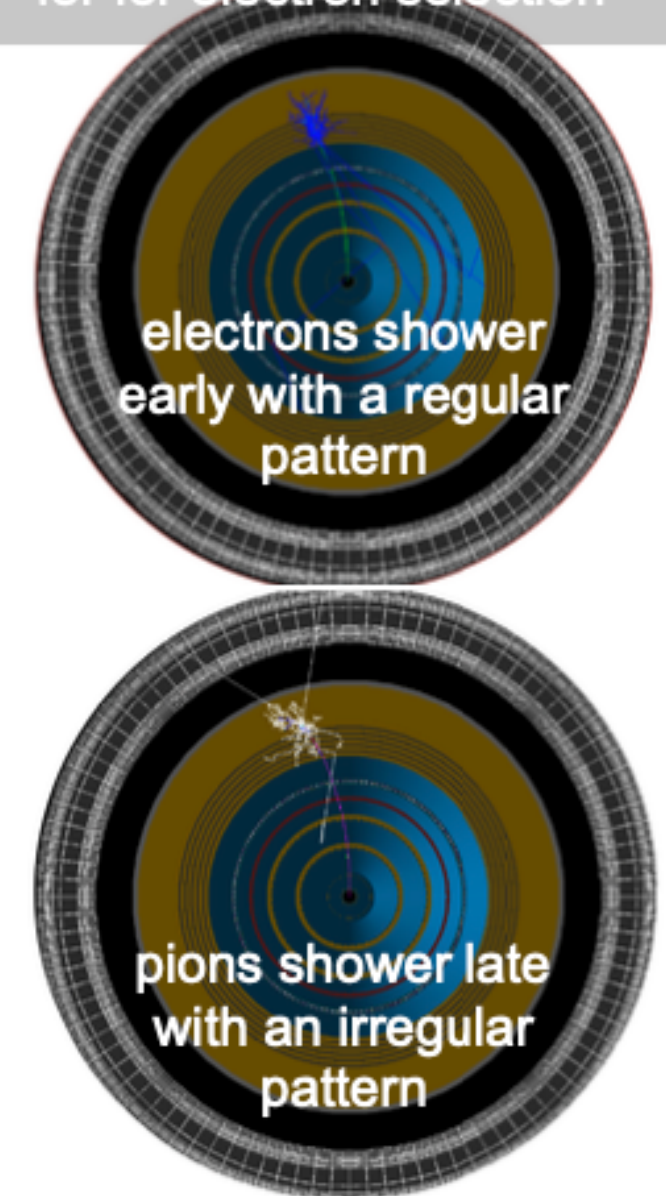
Total thickness $> 17.1 X_0$
Sampling fraction $\sim 10\%$



Large back section of Pb/ScFi

4(+2) planes of AstroPix sensors interleaved with 5 Pb/ScFi layers

Example: 3D Shower Imaging for electron selection



Energy resolution - Primarily from Pb/ScFi layers (+ AstroPix energy information)
Position resolution - Primarily from Imaging Layers (+ 2-sided Pb/ScFi readout and ϕ -R segmentation)

M.Jadhav (ANL) @ PIXEL 2024

B.Kim+2025, PoS(VERTEX2025)

AstroPix Series

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2020

2021

2022

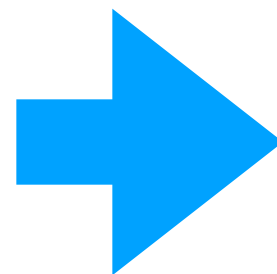
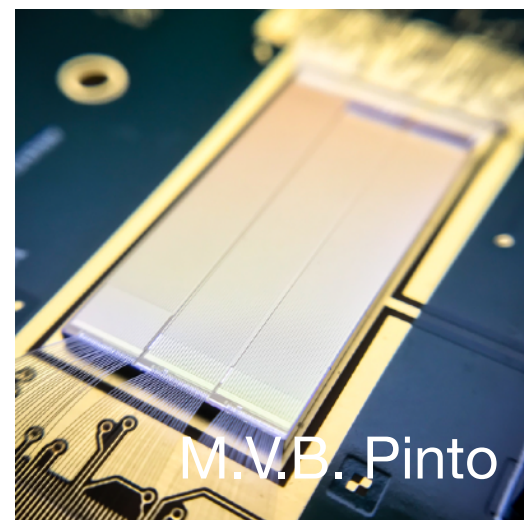
2023

2024

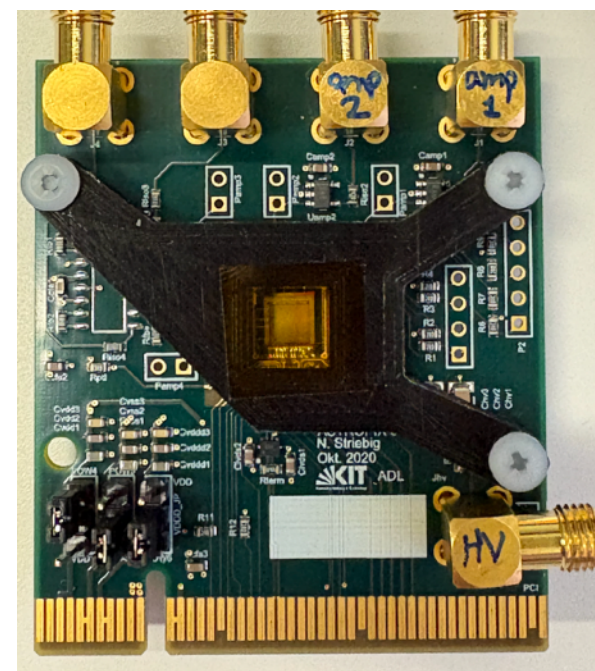
2026

MuPix

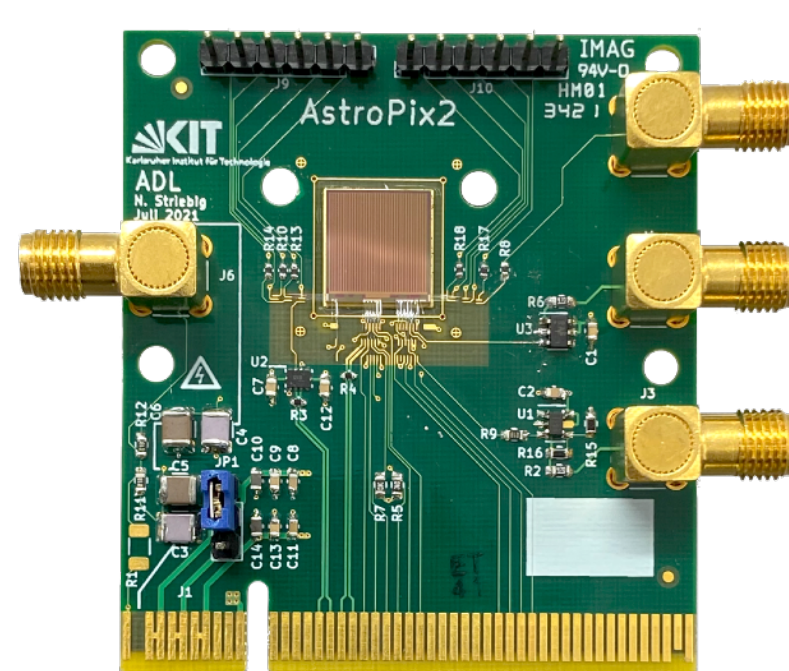
ATLASPix



AstroPix v1



v2



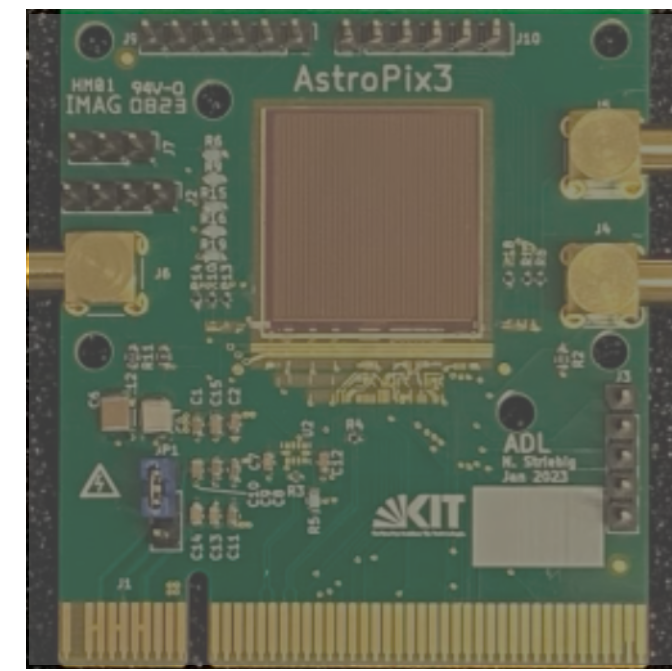
v3



v4



v5



Pitch: 150 x 50 μm

175 x 175 μm

250 x 250 μm

500 x 500 μm

500 x 500 μm

Power: 160 mW/cm²

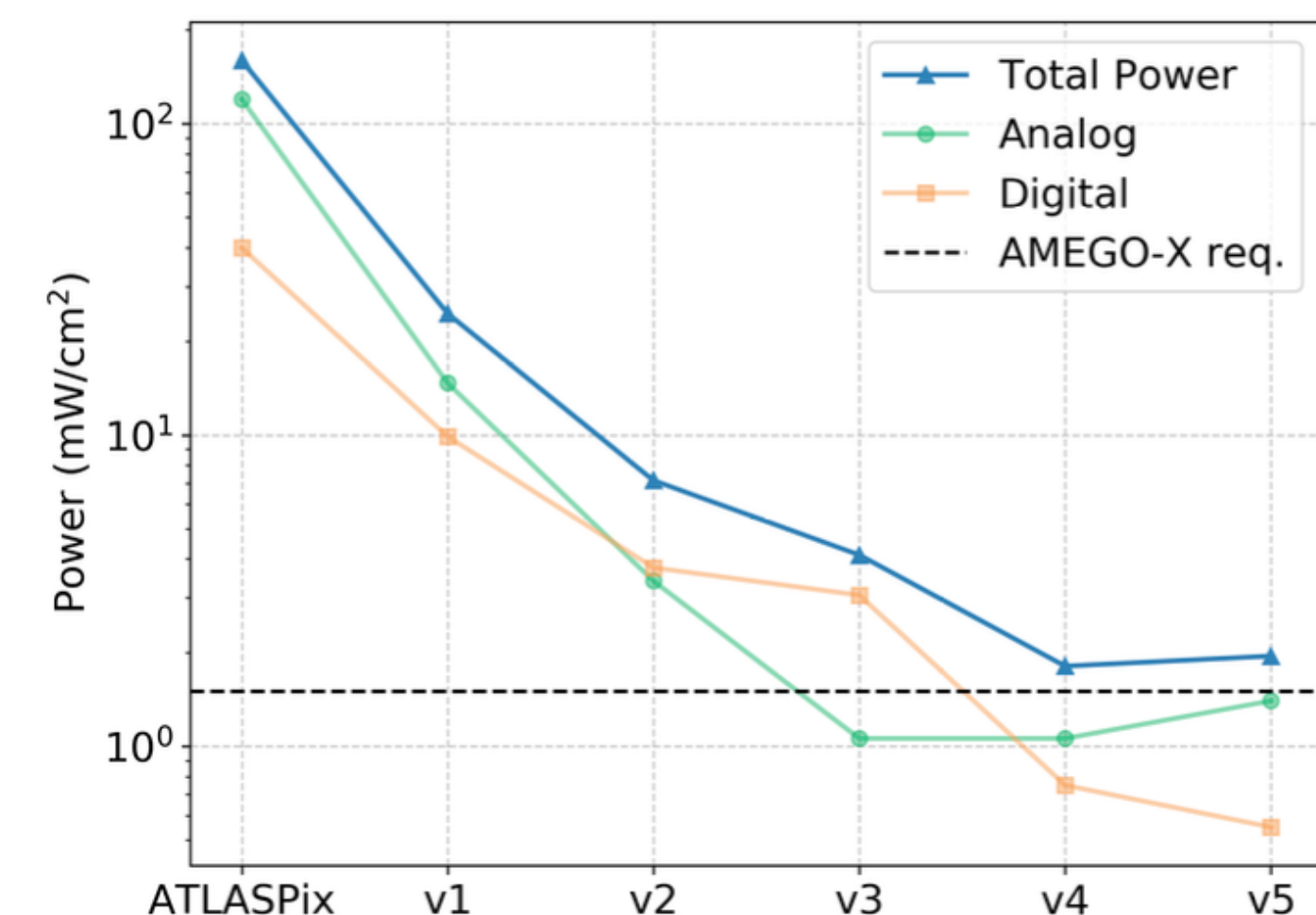
24.6 mW/cm²

7.2 mW/cm²

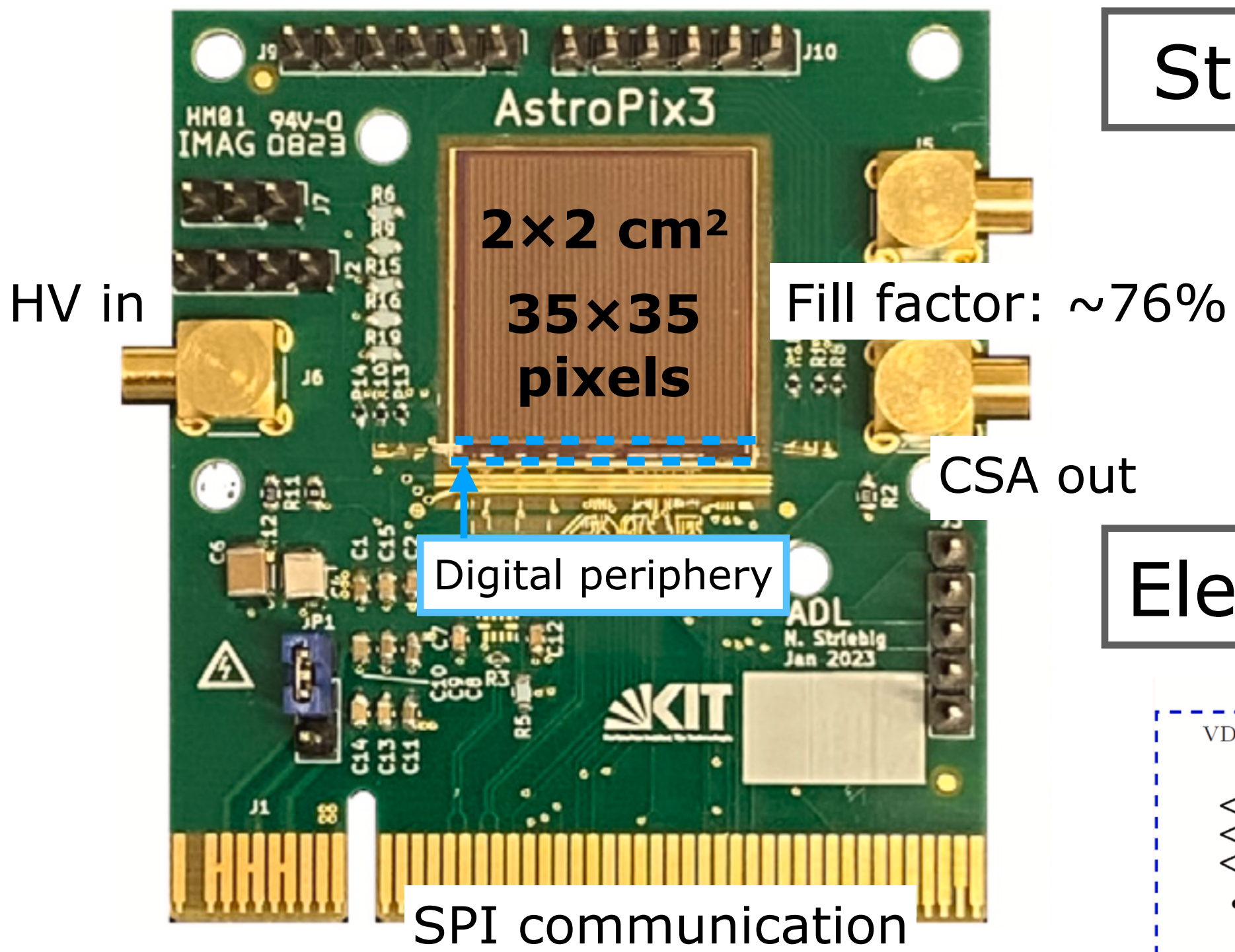
4.1 mW/cm²

2 mW/cm²

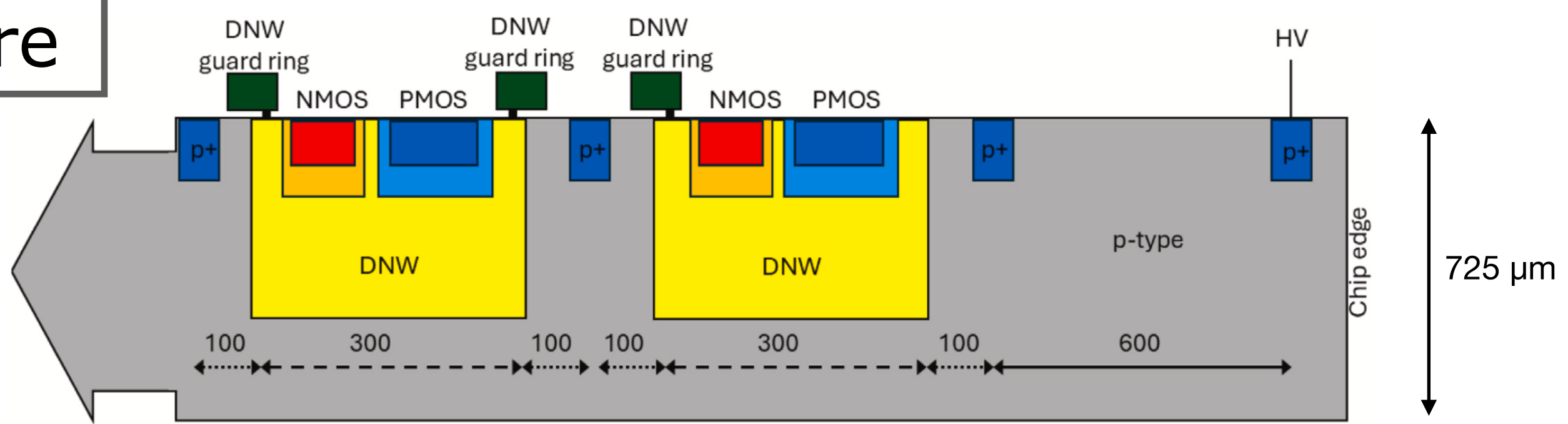
- PI: R. Caputo (GSFC/NASA)
- Design: Karlsruhe Institute of Technology based on ~20 years of experience in HV-MAPS
- AstroPix1: First prototype. Analog readout only
- AstroPix2: Digital readout capability
- AstroPix3: Full reticle chip, 2 x 2 cm². Large pixel pitch, 500 μm
- AstroPix4, AstroPix5, ...



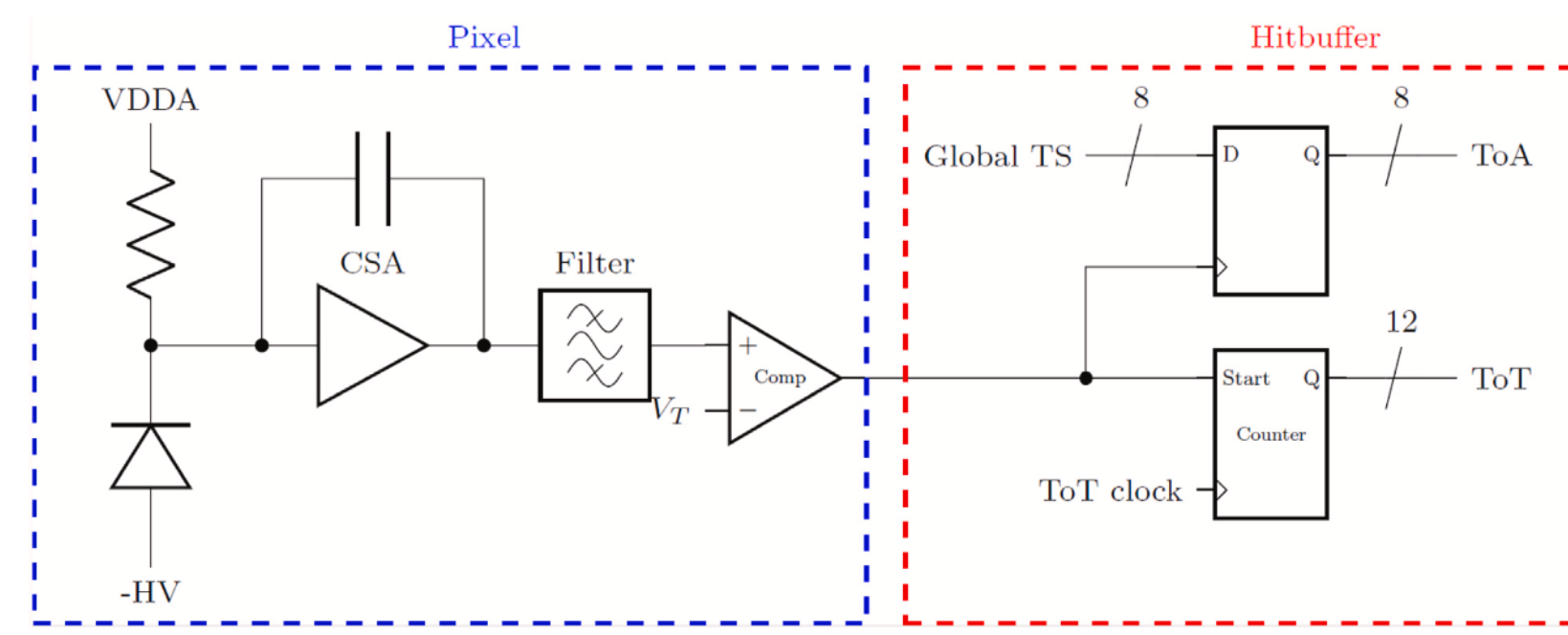
AstroPix3



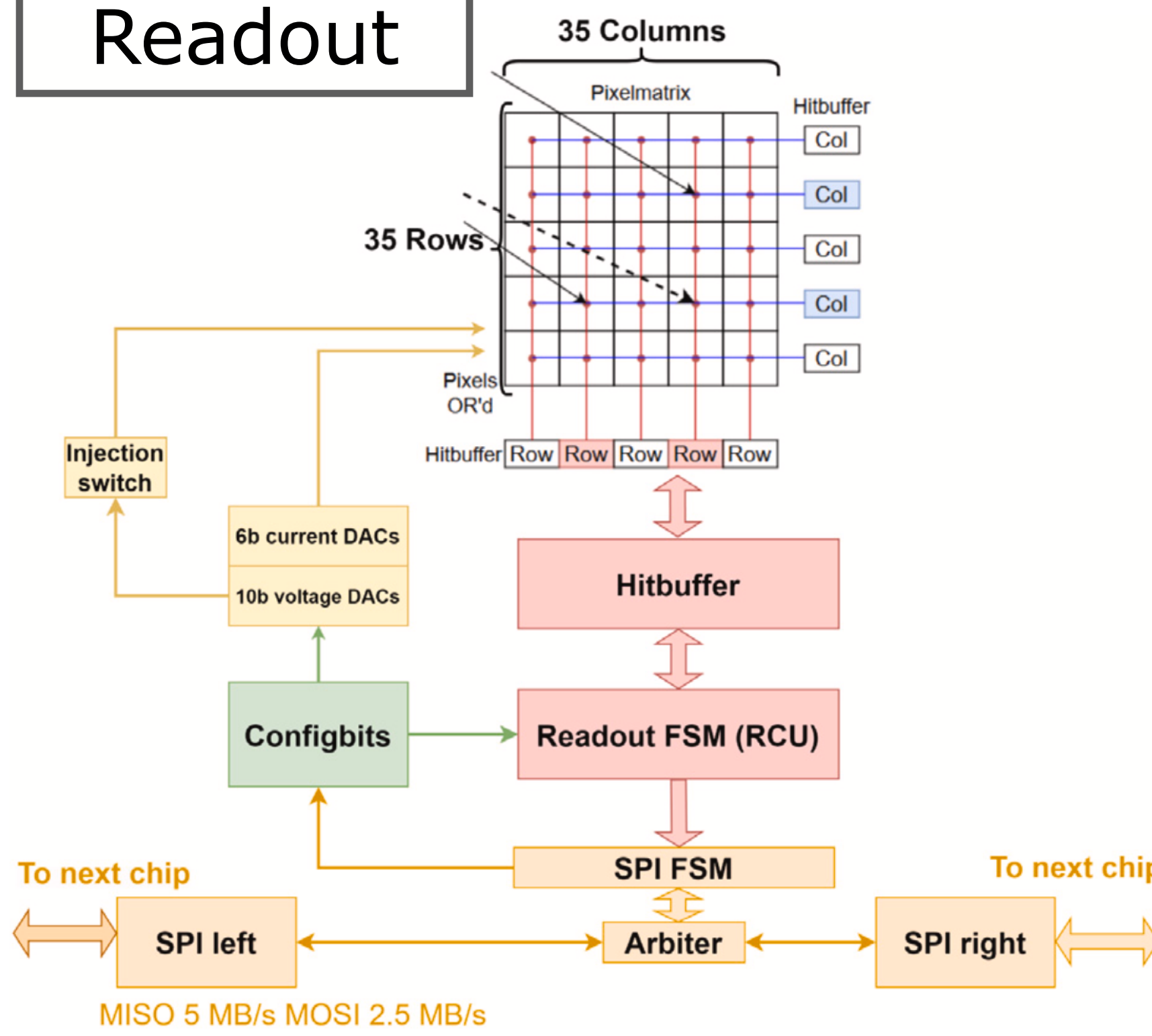
Structure



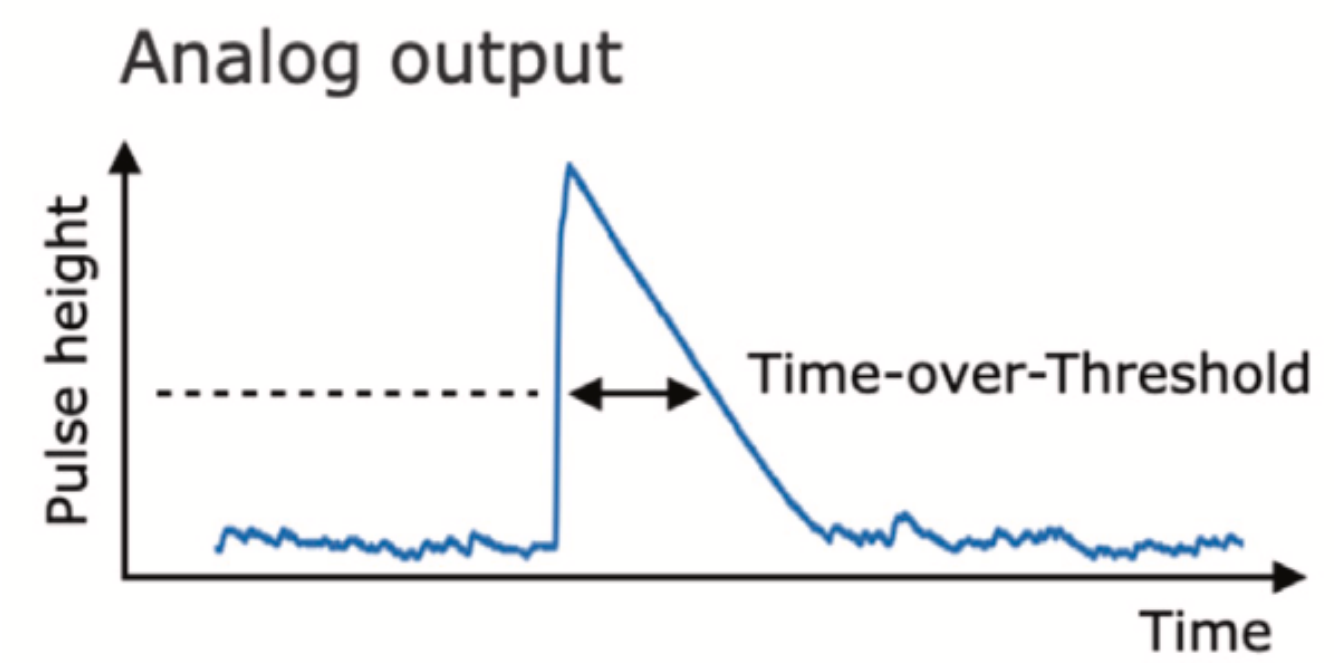
Electronics



Readout



	ATLASPix [5,6]	v1 [7]	v2 [7,8]	v3 [9-11]	Goal [12]
E_{res} [keV]	$7.3 \pm 1.2\%$	$20 \pm 7.4\%^*$	$15 \pm 3\%$	$10.4 \pm 3.2\%^\diamond$	10%
(FWHM)	at 30.1	at 30.1	at 30.1	at 59.5	at 122
Pitch [μm]	150 x 50	175 x 175	250 x 250	500 x 500	500 x 500
Thick [μm]	100	725	725	725	525
Dep. [μm]	48 [■]	N.M.	N.M.	$94 \pm 6^\Delta$	500
Range [keV]	5-32	14-122	14-80	22-200	25-700
Analog [mW/cm ²]	120	14.7	3.4	1.06	1.0
Digital [mW/cm ²]	40	9.9	3.75	3.06	0.5

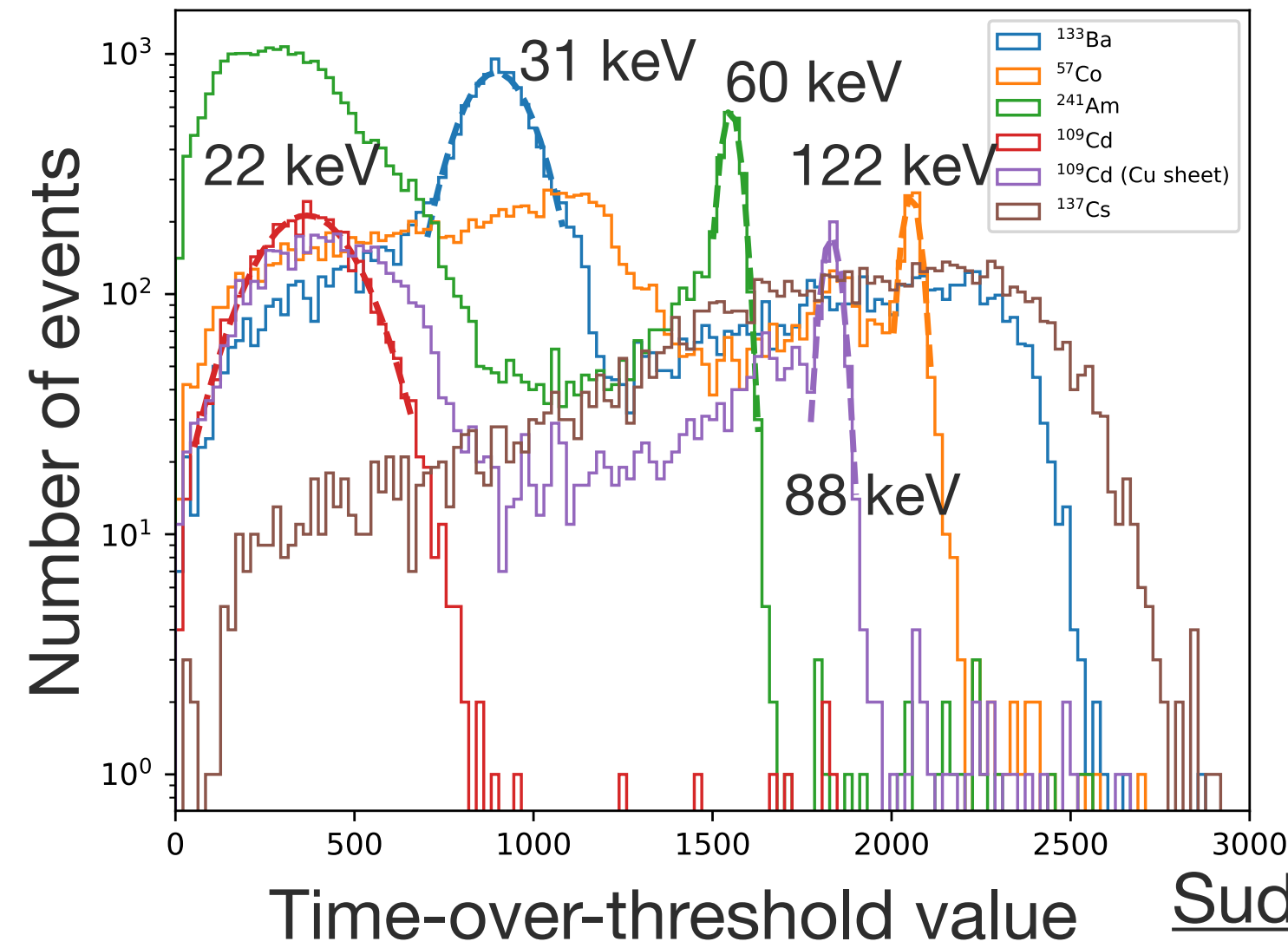


Steinhebel+25 NIMA

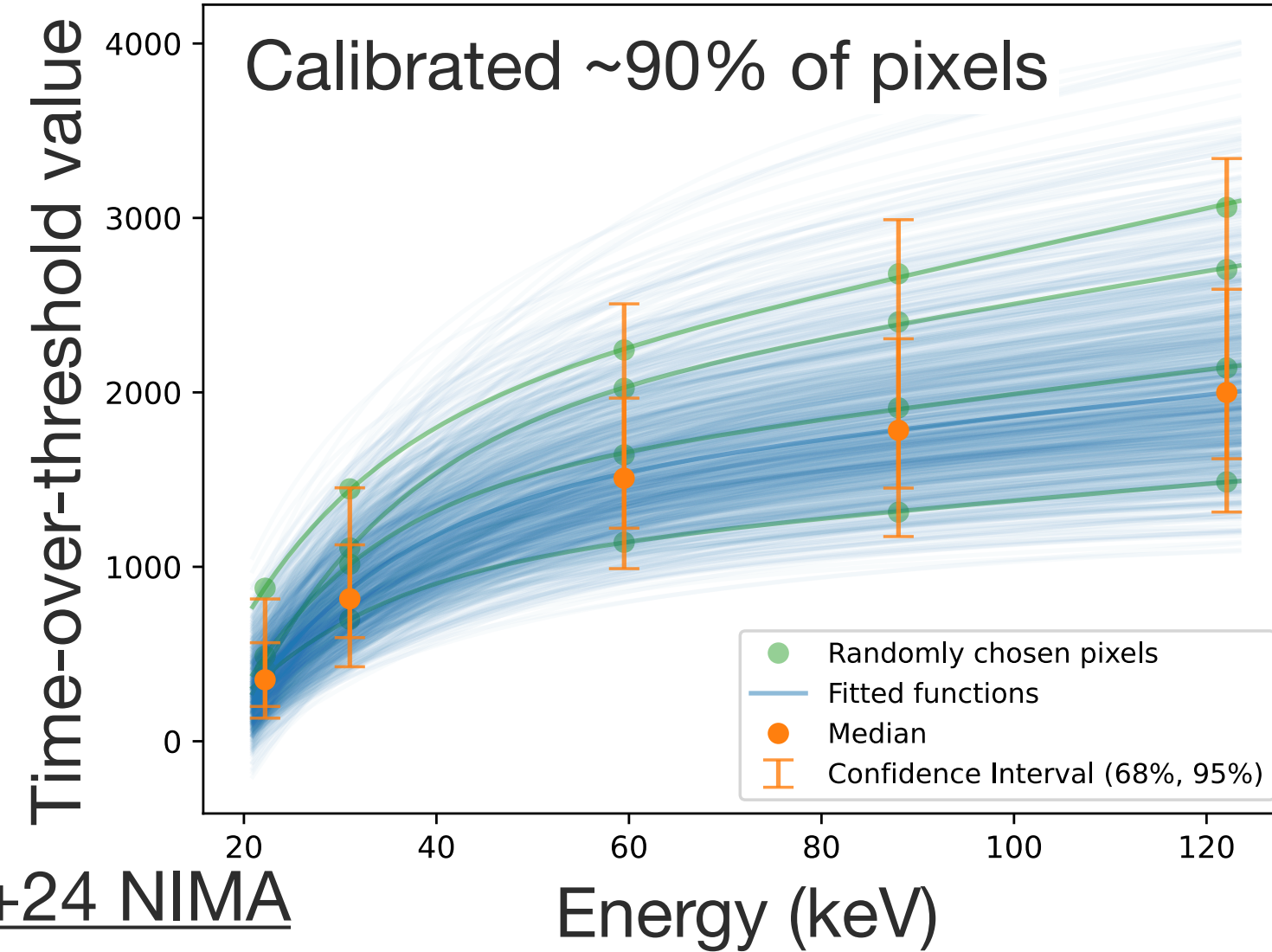
AstroPix3: Performance

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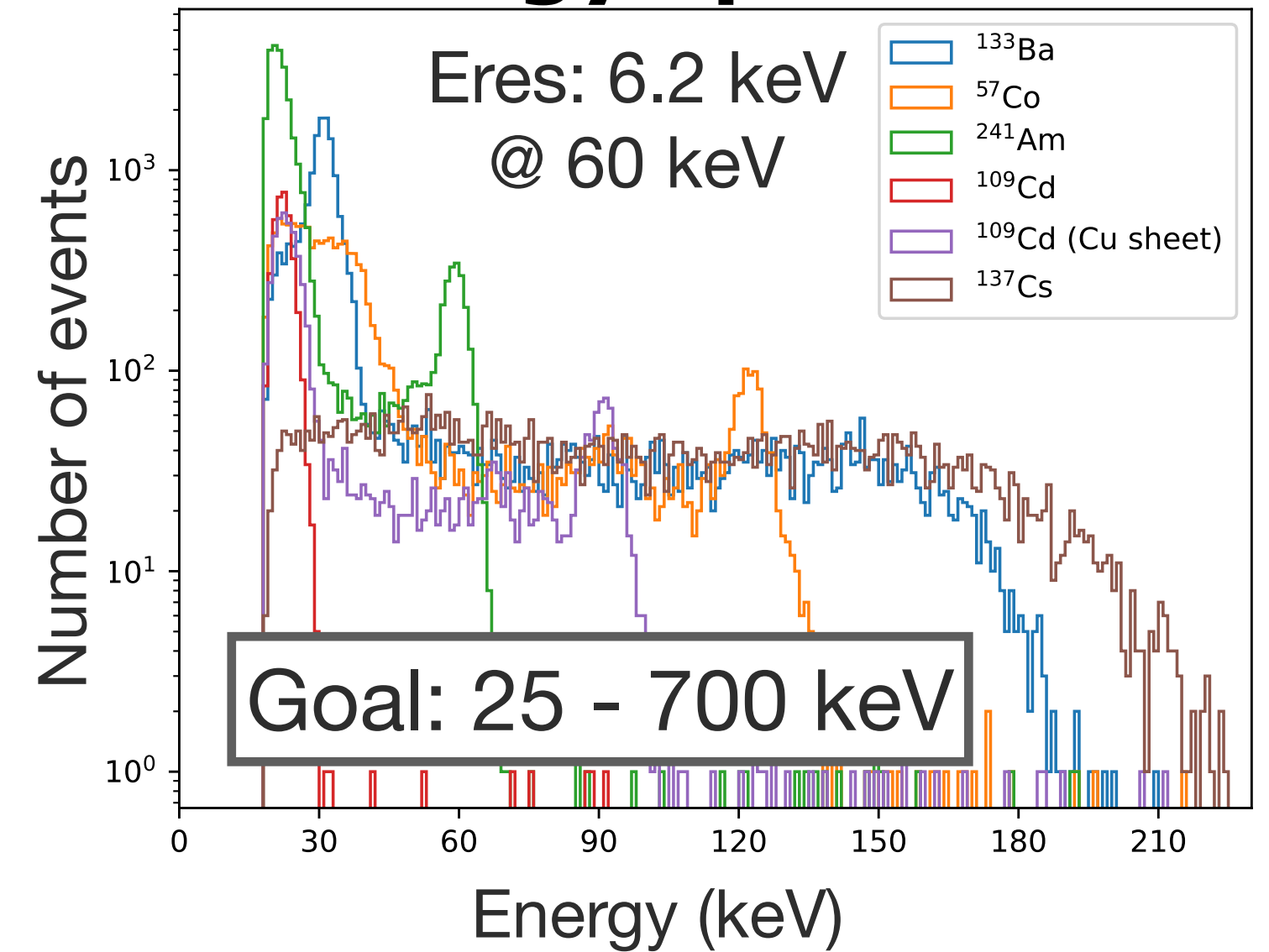
ToT spectra



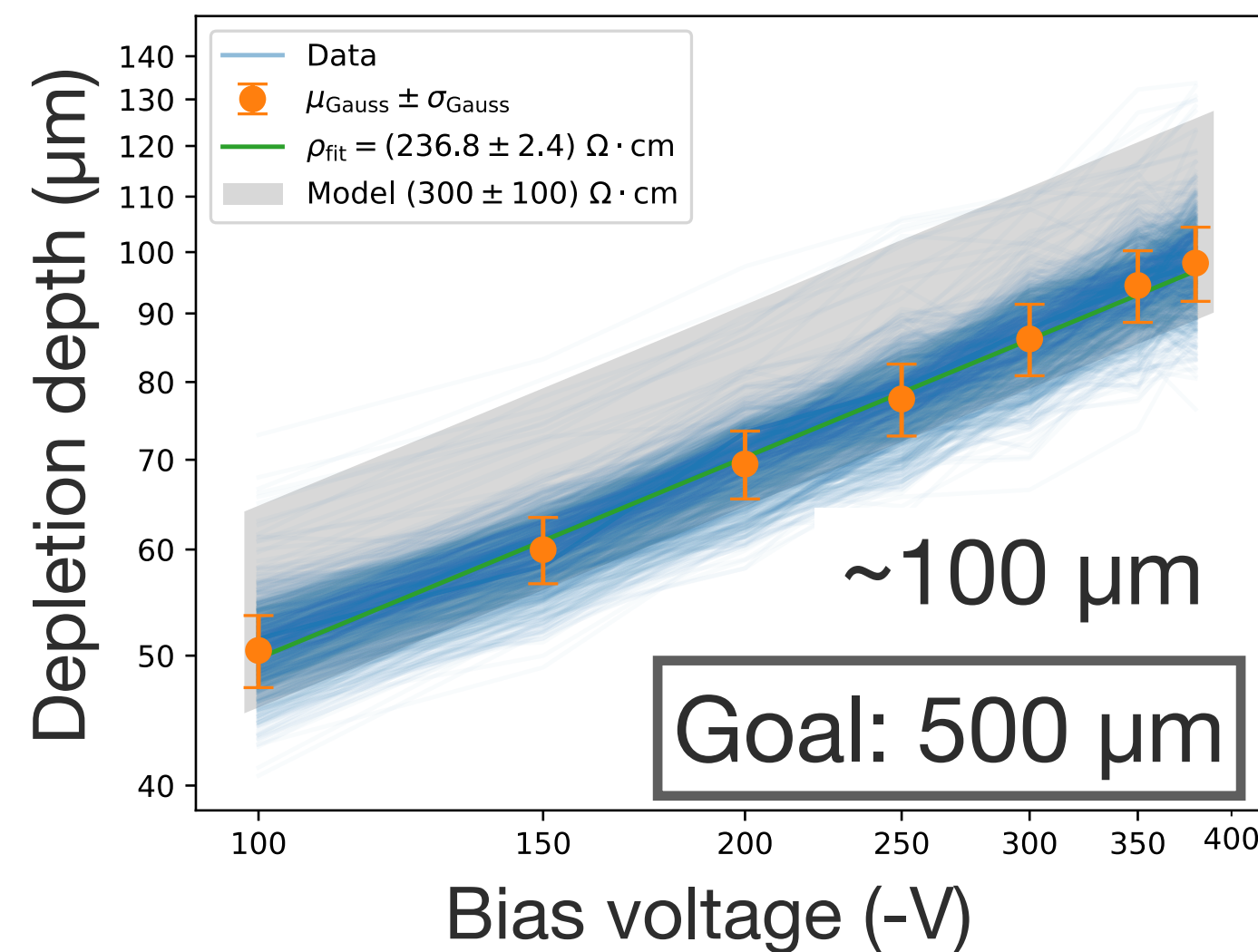
Calibration curves



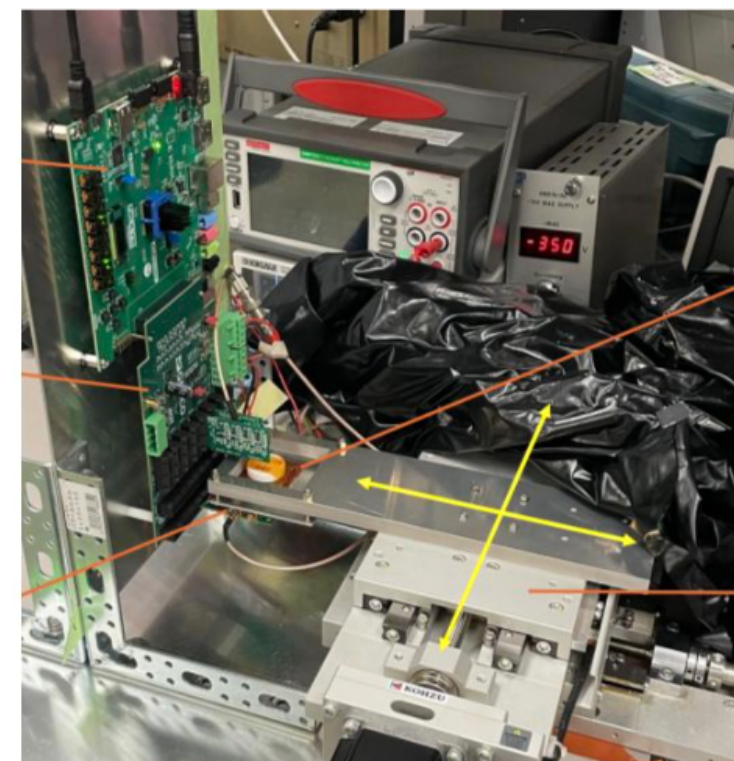
Energy spectra



Depletion depth

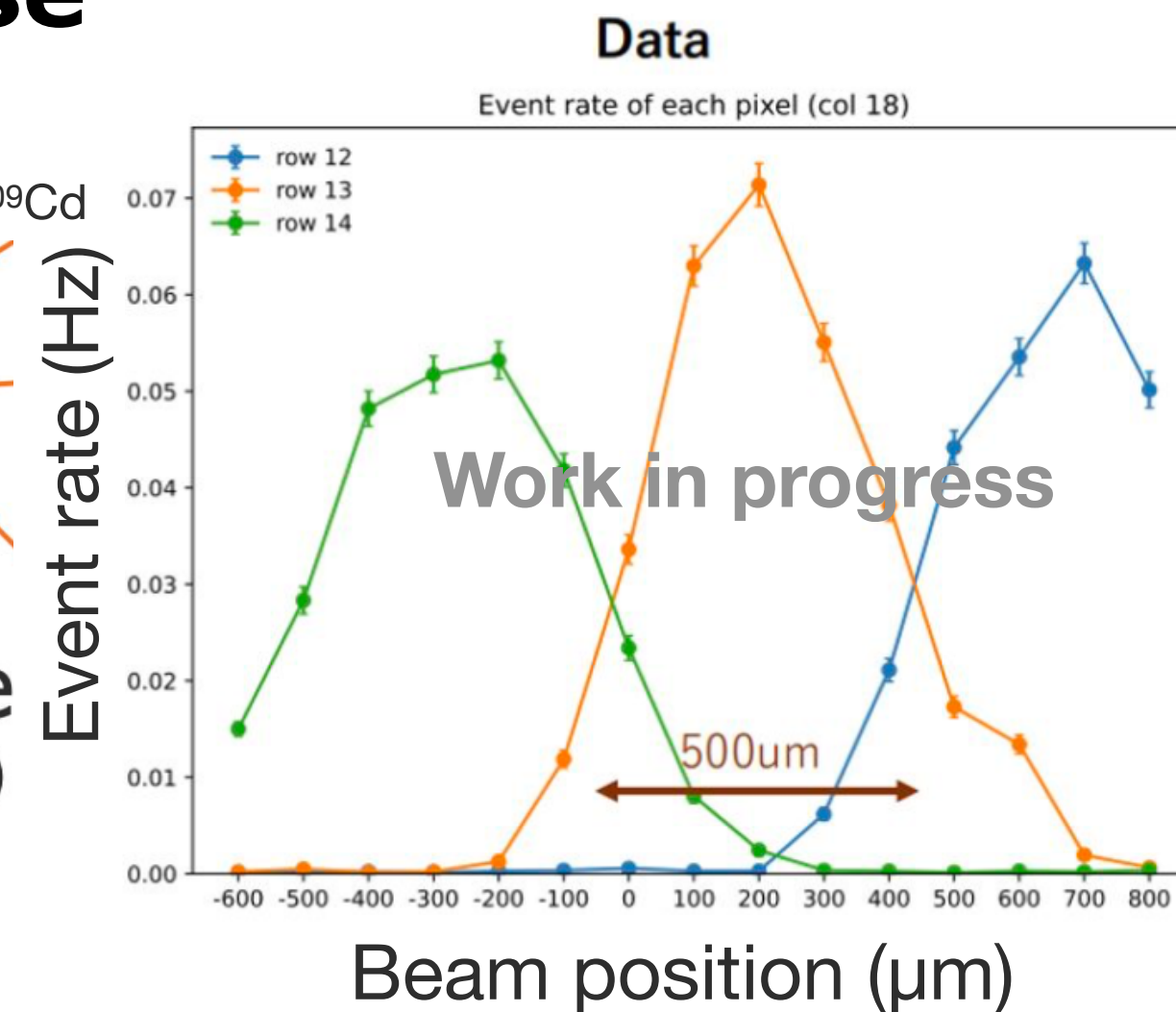


Sub-pixel response

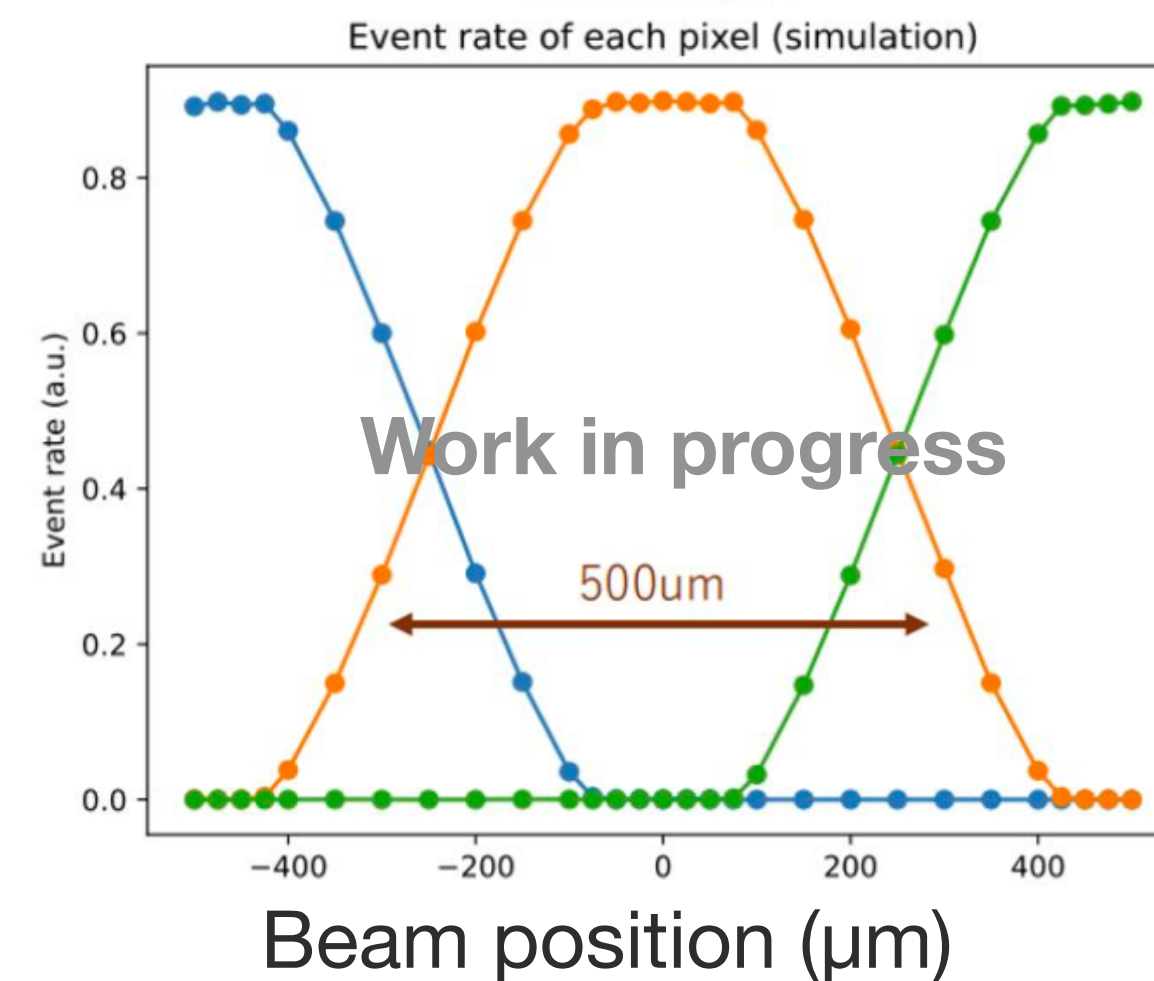


XY stage
(1 $\mu\text{m}/\text{step}$)

^{109}Cd
Event rate (Hz)



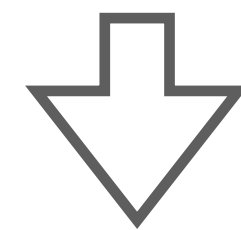
Simulation



国産低消費電力ピクセルセンサ

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- CubeSat・素核実験・医療・月面なども視野に国産で持っておきたい



- 完全空乏実績のあるXRPIXをベースに低消費電力チップを作ろう！

コンプトンカメラの角度分解能
vs. ピクセルピッチ

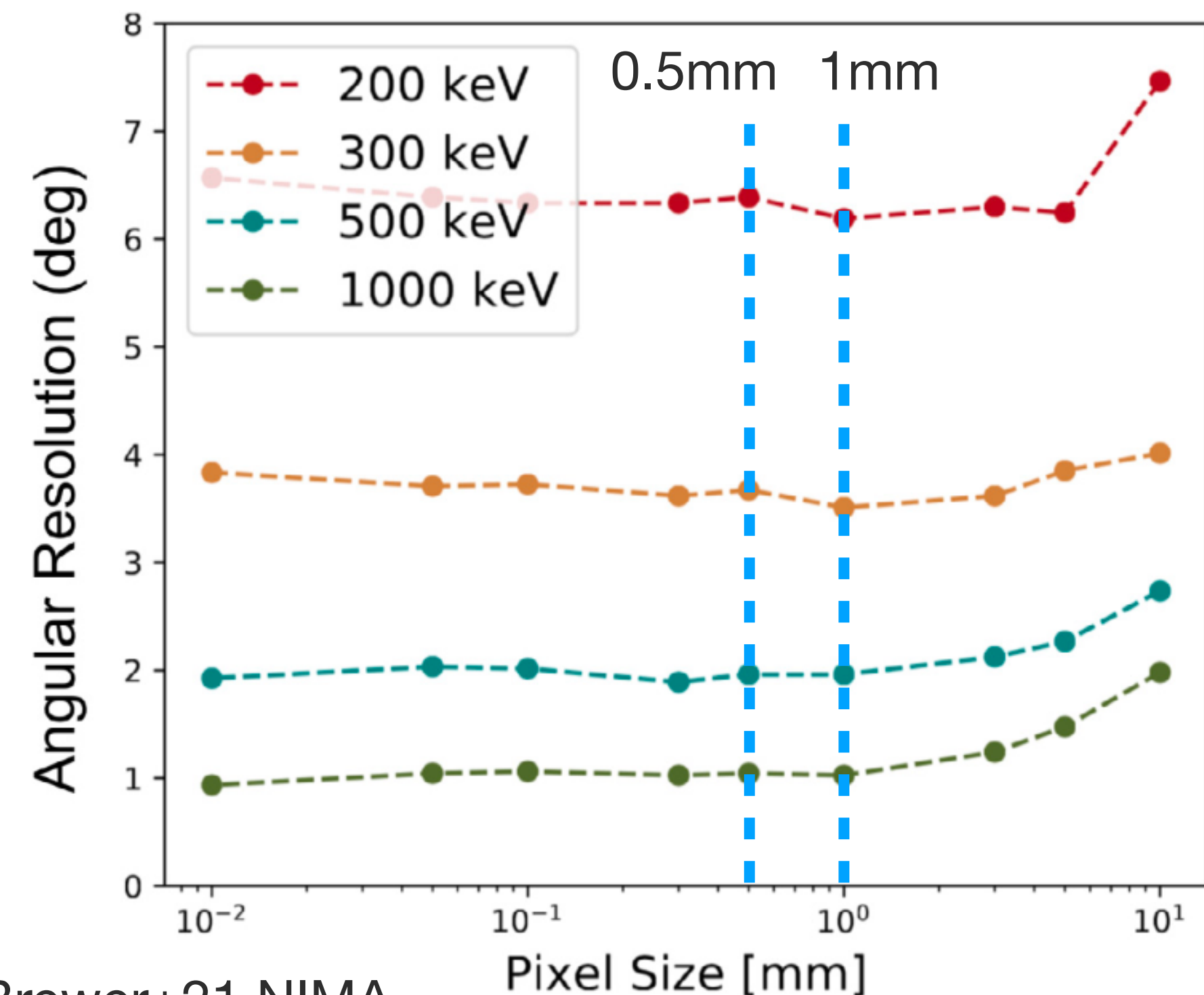
- ピクセルの巨大化 (36 μm $\rightarrow$ 500 μm)

- 消費電力： $\sim 140 \text{ mW/cm}^2$ @XR10 $\rightarrow 1 \text{ mW/cm}^2$?

- 電子飛跡は追えないのでパターン判定不要

- 電荷収集が不安

- 実はMeVガンマ衛星的には1mmでも良い

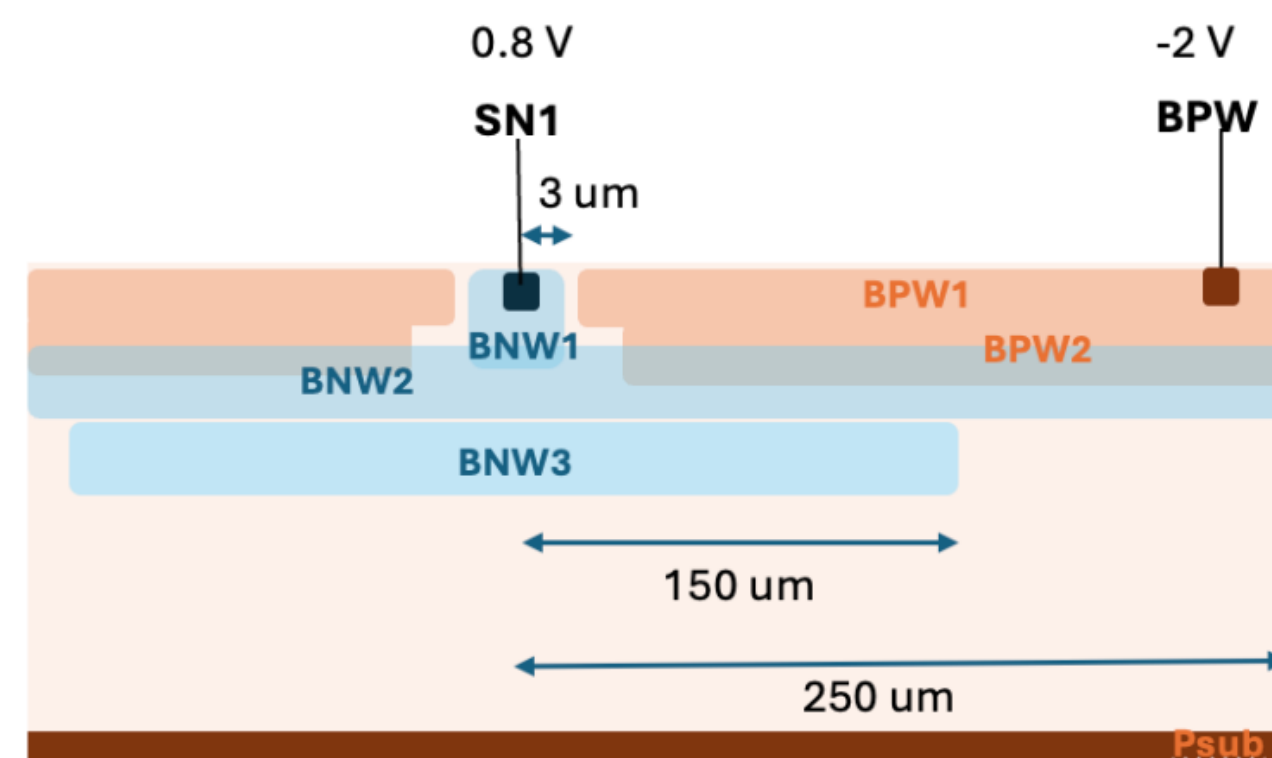


Brewer+21 NIMA

- 提案&出資：須田（広大）
- 設計：武田さん（宮大）
- PD設計サポート：倉知様（D&S）
- アドバイザー：鶴さん（京大），森さん（宮大），新井先生（KEK）
- OROCHI1: 2.9 x 6mm² chip
- XRPIXのPDD構造を拡張した構造2つと全面センスノード構造の3種で電荷収集効率を評価する
- TCAD sim. by 吉田大雅さん（宮大）
- ラピス25年度MPWランにsubmit. 来月納品

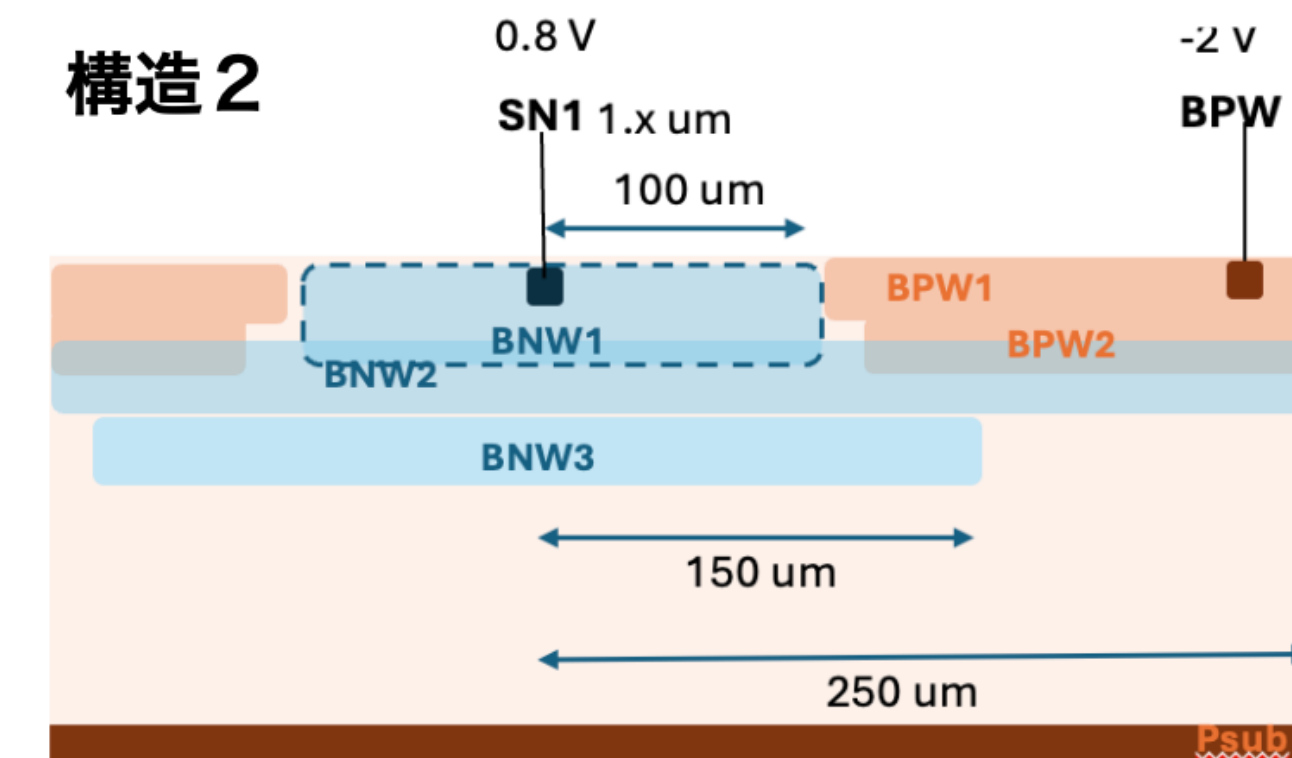
構造 1

1. PDD構造 Baseline

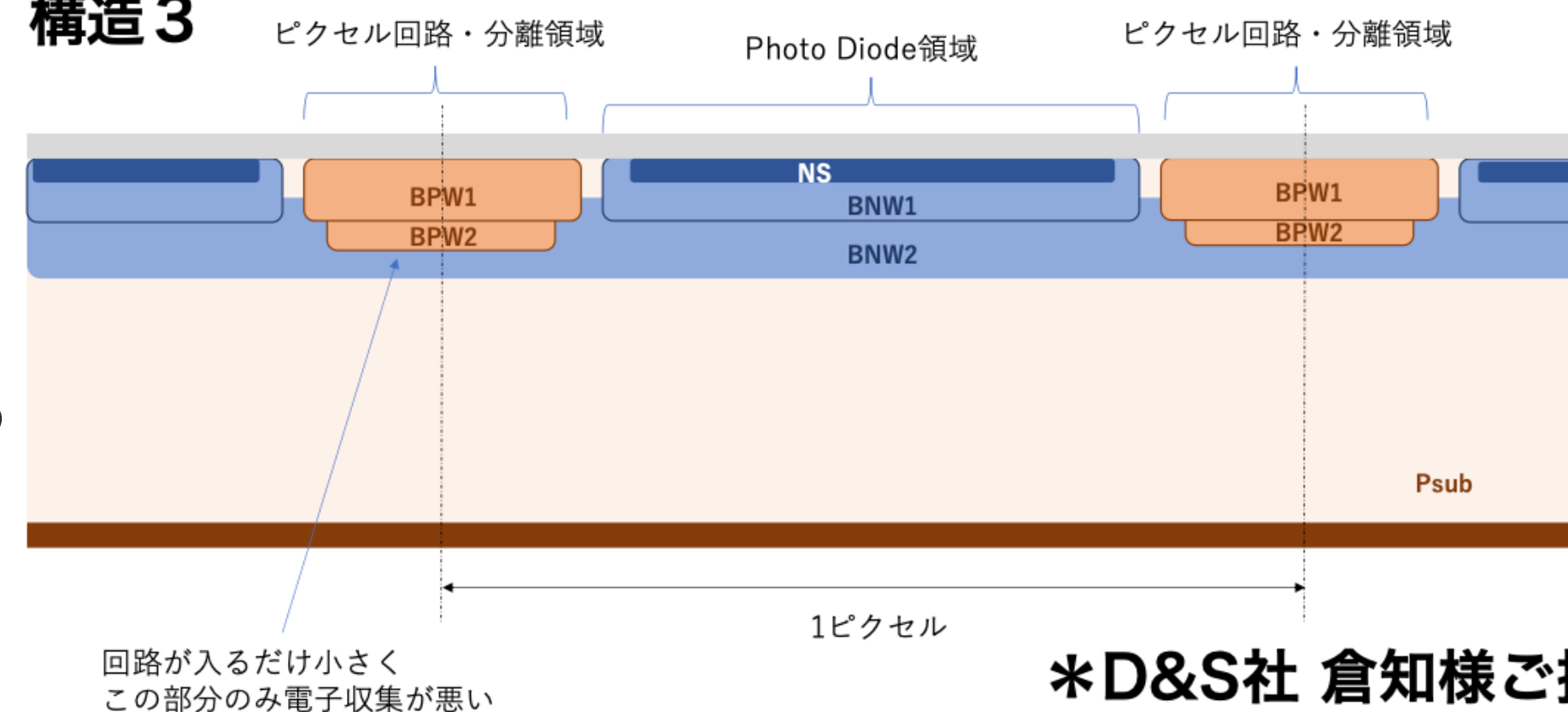


2. PDD構造 Long BNW1

構造 2



構造 3



*D&S社 倉知様ご提案の構造

OROCHI1 構成

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